

**Preliminary Amendment**

Applicant: Michael Bauer et al.

Serial No.: Unknown

(Priority Application No. 10 2004 025 279.3)

(International Application No. PCT/DE2005/000892)

Filed: Herewith

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(International Filing Date: 17 May 2005)

Docket No. I431.145.101/FIN 606 PCT

**Title: SUPPORT WITH SOLDER BALL ELEMENTS AND A METHOD FOR  
POPULATING SUBSTRATES WITH SOLDER BALLS**

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**IN THE SPECIFICATION**

Please insert the following paragraph beginning at page 1, line 6, of the substitute specification with the following paragraph:

**Cross Reference to Related Application**

This Utility Patent Application claims the benefit of the filing date of German Application No. DE 10 2004 025 279.3, filed May 19, 2004, and International Application No. PCT/DE2005/000892, filed May 17, 2005, both of which are herein incorporated by reference.